Abstract Submitted for the MAR14 Meeting of The American Physical Society

Large-area growth of molybdenum disulphide monolayers for integrated photonics<sup>1</sup> Y. JIA, T. STANEV, E. LENFERINK, N.P. STERN, Department of Physics and Astronomy, Northwestern University — Electronic devices based on single/few-layer transition-metal dichacogenide semiconductors heavily rely on mechanically exfoliated micro-flakes. Uncontrollable position and dimension are significant obstacles to integration of electronics and photonics using these layered two-dimensional materials. In this report, we grow continuous few-layer  $MoS_2$  film on  $SiO_2/Si$  wafers using a cost-effective solution process and thermal decomposition. The number of the layers can be controlled by the spin-coating rate of the solution. Multi-layers can be controllably reduced layer-by-layer using an Ar-plasma etch. Compared with chemical vapor depositions which usually require temperature of 600-900 C, the low temperature of 450 C used here offers more flexibility in MoS<sub>2</sub> direct growth on other materials such as flexible plastic substrates. The good crystalline quality over area of  $50 \times 50 \ \mu m^2$  and the controlled layer thickness enable broad applications of 2D semiconductor films to realizing integrated photonic devices.

<sup>1</sup>NPS acknowledges support as an Alfred P. Sloan Research Fellow.

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Date submitted: 15 Nov 2013

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